



# PRODUCT SPECIFICATION

## 產品規格書

產品名稱 Description	產品料號 Part No.	圖號 Drawing No.
Offset 4.25mm, M-CRPS 73.5mm	9305-4PxxSxxxxSxxxx	9305-DPxxSxx-xxx

<b>PRODUCT NAME</b> 產品名稱	<b>DOCUMENT No.:</b> 文件編號	<b>Rev.</b> 版本	<b>OUPIIN</b>
Offset 4.25mm, M-CRPS 73.5mm	Q9305-PSS-001	M	歐品電子
	<b>Approved</b> 核准	<b>Checked</b> 審核	<b>Prepared</b> 制作



# PRODUCT SPECIFICATION OF Oupiin

## 1. SCOPE 適用範圍

This product specification defines the product performance and the test methods to ascertain the performance of the Offset 4.25mm, M-CRPS 73.5mm, which is designed and manufactured by Oupiin Electronic Co., Ltd. This product specification is applicable but not only for those part numbers which be shown in the cover page.

本產品規格書規定了由歐品電子有限公司設計生產的 Offset 4.25mm, M-CRPS 73.5mm 型連接器產品的特性及測試方法。本產品規格書適用於但不局限於封面所顯示的產品料號。

## 2. REFERENCE DOCUMENTS 參考文件

MIL-STD-1344	Test method for electrical connector 電子連接器測試方法
MIL-STD-202	Test method for electrical components 電子零件測試方法
EIA364	Test method for electrical components 電子零件測試方法
JIS C 0051	Test method for electrical components 電子零件測試方法
MIL-G-45204C	Specification for gold plating 鍍金規格
IEC-512-3	IEC standard for current carrying capacity tests IEC 電流測試標準
QQ-N-290A	Specification for nickel plating 鍍鎳規格
MIL-P-81728A	Specification for tin/lead plating 鍍錫鉛規格
MIL-T-10727B	Specification for tin plating 鍍錫規格
UL 1977	UL standard for safety of attachment plug and receptacle UL 安規要求標準

## 3. FEATURE & DIMENSIONS 特征及尺寸

### 3.1. PRODUCT DIMENSION 產品尺寸

These connectors shall have the dimensions as shown in drawing.

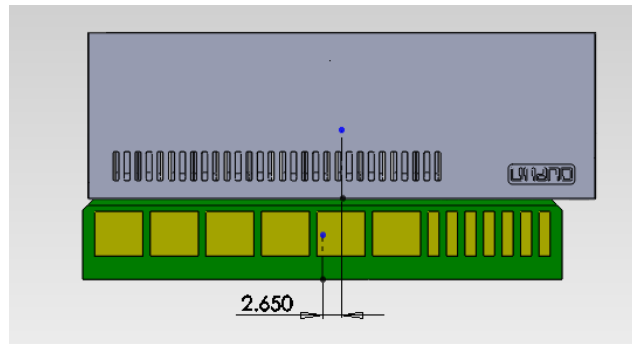
本產品的相關尺寸參見圖面。

### 3.2. MALE AND FEMALE PRODUCT 公母產品裝配

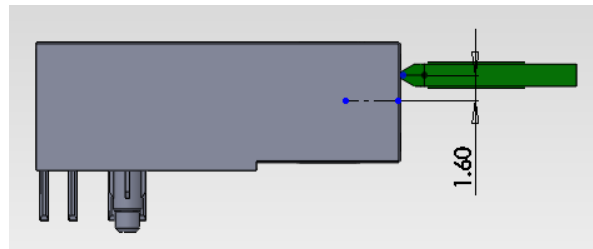
#### 3.2.1. Perpendicular to engaging direction 垂直插入方向

the design of the centering and guiding in the mpc of the free and fixed board connector modules shall accept a misalignment of 2.65mm in transverse and 1.60mm in longitudinal axes of the connector

固定板連接器模件的Mpc裡，連接器設計中心線橫向可接受2.65mm和縱向可接受1.60mm的偏差。



allowed misalignment in transverse axes 在橫向方向允許對插偏差量

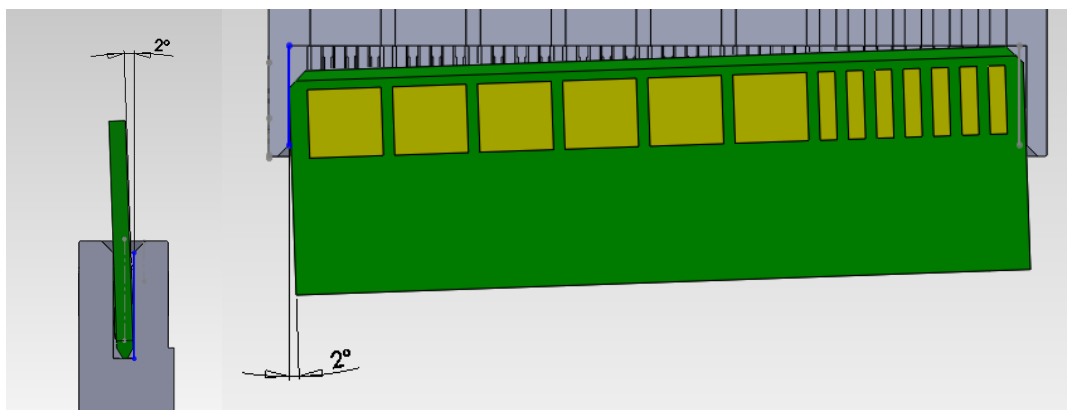


allowed misalignment in longitudinal axes 在縱向方向允許對插偏差量

### 3.2.2 Inclination 傾向

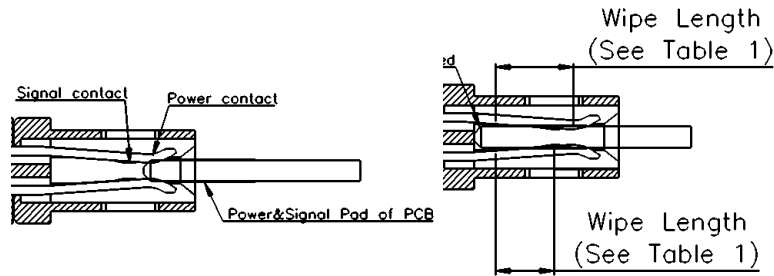
The center and guiding in the Mpc OF the free and the fixed board connector modules shall allow an initial angular misalignment of 2° Max in the transverse and longitudinal axes

固定板連接器模件的在Mpc裡,連接器可接受橫向和縱向2° 的最大傾斜對插角度。



### 3.2.3 Capability for products wipe length

產品接觸長度等級



CONTACT	MATING LEVEL	WIPE LENGTH(MIN)
Power Pin	1	4.9mm
Signal Pin	1	3.4mm

### 3.2. PCB/PANEL LAYOUT 印刷電路板佈局

The recommended PCB layout is shown in drawing.

本產品適用的 PCB layout 參見圖面。

### 3.3. BILL OF MATERIAL 材料清單

Harmful material controlling follows the requirements of RoHS. The bill of material is described in drawing.

有害物質控制符合 RoHS 指令要求。本產品使用的材料參見圖面。

### 3.4. MECHANICAL & ELECTRICAL CHARACTERISTIC 機械及電氣特性

The connector shall have the mechanical and electrical performance as described in drawing.

本產品的機械及電氣特性參見圖面。

### 3.5. PACKAGING 包裝

Products shall be packaged according to requirements specified in purchase order for safe delivery, connector container and the packaging method are shown in package specification.

產品可依客戶指定要求包裝。包裝材料與包裝方式參見產品包裝規範。



### 3.6 RATING CURRENT AND RATING VOLTAGE 額定電流與額定電壓

Rating current: Power pin: 55A(UL), Signal pin:4A(UL).  
Power pin: 51.5A(6ozX6), Signal pin:4A(6ozX6).

額定電流: Power pin: 55A(UL), Signal pin: 4A(UL) .  
Power pin: 51.5A(6ozX6), Signal pin:4A(6ozX6).

Rating voltage : Power pin 250V Signal pin 30V.

額定電壓 Power pin 250V Signal pin 30V

### 3.7 STORAGE AND OPERATING TEMPERATURE 存貯與使用溫度

Temperature range: -55°C~+105°C, including terminal temperature rise for rating current.

Storage Temperature :0°C~+40°C, Humidity: 80%RH under, Time limit is 18 months the products are stored.

溫度範圍 : -55°C~+105°C,包含接觸端子的額定電流溫升.

儲存溫度 : 0°C~+40°C · 濕度 : 80%RH 以下,產品限存時間為 18 個月.

## 4.Environmental 環境要求

### 4.1. SOLDERABILITY 可焊性

Connectors meet solder-ability to EIA-364-52, and shall be free of contaminants.

產品可焊性符合EIA-364-52標準規定的相關要求 · 表面不得有污染物。

### 4.2. RESISTANCE TO SOLDER HEAT 耐焊接熱

#### 4.2.1. INFRARED REFLOW 紅外線回流焊接

Each cycle consists of three consecutive phases, as shown in **Table III**.

每個焊接週期包括三個連續的階段 · 見附表三。

#### 4.2.2. WAVE SOLDER 波峰焊接

Each cycle consists of three consecutive phases. as shown in **Table IV**.

每個焊接週期包括三個連續的階段,見附表四。

#### **Note:** 說明

Device temperature measurements are referenced from the top-center of the package outer surface.

設備溫度量測時以從頂部中間位置測量為準。



5. PERFORMANCE AND TEST DESCRIPTION 性能及測試

5.1. REQUIREMENT 要求

Product is designed to meet electrical, mechanical, and environmental performance requirements specified in Table I.

本產品設計符合附表一所述的機械、電氣及環境要求。

5.2. TEST CONDITION 測試條件

Unless otherwise specified, all tests shall be performed at ambient environmental conditions.

除非特別注明，所有測試在室溫條件下完成。

5.3. SAMPLE SELECTION 樣品選擇

Test samples shall be selected at random from current production. No test samples shall be reused. Samples are pre-conditioned with 10cycles of durability. Each group shall be containing 5 test samples at least.

測試樣品從現生產的產品中隨機抽取，所有測試過的樣品不得重複使用。樣品已預先插拔 10 次，每組測試至少有 5 個樣品。

5.4. TEST SEQUENCE 測試順序

Product qualification test sequence as shown in Table II.

產品品質測試順序見附表二。

Table I: Test Requirements and Methods

附表一：測試要求與方法

Items 項目	Requirements 要求	Test Methods 測試方法
1. Confirmation of Product 產品確認	Product shall be conforming to the requirements of applicable product drawing. 產品必須符合相關產品圖面的要求。	Visually, dimensions and functionally inspected per applicable product drawing. 依相關產品圖面，檢查產品的外觀、尺寸及功能
2. Contact Resistance 接觸阻抗	Power pin:0.6 mΩ Max.initial. Signal pin:20 mΩ Max.initial. Contact resistance change△10 mΩ Max Power pin 初始狀態 0.6mΩ Max, Signal pin 初始狀態 20mΩ Max, Signal pin 接觸電阻變化值 △10 mΩ Max	Subject mated contacts assembled in housing to closed circuit of 20 mA max. voltage 20 mV max. Per EIA-364-06 所述固定端子連結到一個封閉回路中測試,電流 20 mA max,電壓 20 mV max。適用：EIA - 364-06



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<p>3. Insulation Resistance 絕緣阻抗</p>	<p>Power pin: 5000 MΩ Min. Signal pin : 5000 MΩ Min Power pin 最小 5000 MΩ. Signal pin 最小 5000 MΩ</p>	<p>Measure by applying test potential between the adjacent contacts, and between the contacts and ground in the mated connector. (500 V DC±10%),Per EIA -364-21 . 測試產品相鄰端子間以及端子與接地間的電阻 (500 VDC±10%),適用：EIA -364-21 。</p>
<p>4. Dielectric Withstanding Voltage 耐電壓</p>	<p>Power pin and Signal pin must withstand test potential of 1000 VAC RMS for 1 minute, current leakage must be 5.0mA Max Power pin 和 Signal pin 必須承受測試電壓 1000 VAC RMS · 時間 1 分鐘 · 漏電流不 大於 5.0 mA 。</p>	<p>Measure by applying test potential between the adjacent contacts, and between the contacts and ground in the mated connector. Per EIA-364-20. 對產品相鄰端子間以及端子與接地間加載電壓 · 並測試其漏電流 · 適用：EIA-364-20 。</p>
<p>5. Durability (Repeated Mating/Un-mating) 耐久性</p>	<p>Power contact resistance less than 0.6 mΩ and signal contact resistance change 10 mΩ max. After testing. 測試後電源針接觸阻抗不超過 0.6 mΩ · 信號針接觸阻抗比初始值增大不超過 10 mΩ 。</p>	<p>Repeat mate and unmated for connector 200 cycles, at a speed of 25.4±3 mm per minute. Per EIA-364-09 重復進行配合產品 200 次插拔 · 速度 25.4±3 mm/分鐘 · 適用：EIA-364-09 。</p>
<p>6. Contact Retention Force 端子保持力</p>	<p>Signal pin: 5N/Pin. Min. Power pin: 15N/Pin. Min. Signal pin 每支最小 5N. Power pin 每支最小 15N</p>	<p>Apply axial pull out force at a speed of 25.4±3 mm/minute on the contact assembled in the housing. Per EIA-364-29. 以 25.4±3mm/分鐘的速度施加軸向拉力從塑膠本體上拔出端子 · 適用：EIA-364-29 。</p>
<p>7. Mating /Un-mating Force 插入力/拔出力</p>	<p>Power Pin : Mating force:10N /Pin Max. Un-mating force:2.0N /Pin Min Signal Pin : Mating force:1.5N /Pin Max. Un-mating force:0.36N /Pin Min Power Pin: 插入力最大: 10N /Pin Max 。 拔出力最小: 2.0N /Pin Min 。 Signal Pin : 插入力最大: 1.5N /Pin Max 。 拔出力最小: 0.36N /Pin Min</p>	<p>At a speed of 25.4±3 mm/minute, apply axial insert the mating part into fully or pull out from the subject product. Per EIA-364-13. 以 25.4±3 mm/分鐘的速度 · 軸向完全插入對配插件到被測產品中或從被測產品中拔出 · 適用：EIA-364-13 。</p>



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<p>8. Vibration 機械振動</p>	<p>No electrical discontinuity greater than <math>1\mu\text{s}</math> shall occur, Power contact resistance <math>0.6\text{ m}\Omega</math> max and signal contact resistance change <math>10\text{ m}\Omega</math> max. After testing. 不允許出現超過 <math>1\mu\text{s}</math> 的瞬間斷開。測試後電源針接觸阻抗最大 <math>0.6\text{m}\Omega</math>，信號針接觸阻抗比初始值增大不超過 <math>10\text{ m}\Omega</math>。</p>	<p>Subject mated connector to 10-500 Hz traversed in 1 minute at 1.5mm amplitude, 2 hours each of 3 mutually perpendicular planes, 10 mA potential applied. Per EIA-364-28. 對測試產品，在頻率變化每分鐘從 10-500 Hz, 振幅 1.5 mm 條件下，在互相垂直的三個面上，每個面 2 小時下測量，電流 10 mA。適用：EIA-364-28。</p>
<p>9. Thermal Shock 溫度沖擊</p>	<p>After testing, no damage, Dielectric Withstanding Voltage should be OK, Power contact resistance <math>0.6\text{m}\Omega</math> max and signal contact resistance change <math>10\text{ m}\Omega</math> max. 測試後產品無損壞，耐電壓測試 OK，電源針接觸阻抗最大 <math>0.6\text{m}\Omega</math>，信號針接觸阻抗比初始值增大不超過 <math>10\text{ m}\Omega</math>。</p>	<p>Temperature range from <math>-55^{\circ}\text{C}</math> to <math>+85^{\circ}\text{C}</math>. Start from <math>-55^{\circ}\text{C}</math>, after 30 minutes, change to <math>+85^{\circ}\text{C}</math>; change time is no more than 5 minutes, total 5 cycles. Per EIA-364-32. 溫度變化範圍：<math>-55^{\circ}\text{C}\sim +85^{\circ}\text{C}</math>。從 <math>-55^{\circ}\text{C}</math> 開始，30 分鐘後換到 <math>+85^{\circ}\text{C}</math>，轉換時間不超過 5 分鐘，共 5 個循環。適用：EIA-364-32。</p>
<p>10. Mechanical Shock 機械沖擊</p>	<p>No electrical discontinuity greater than <math>1\mu\text{s}</math>. 電流瞬斷時間小於 <math>1\mu\text{s}</math>。</p>	<p>Accelerate Velocity: <math>490\text{m/s}^2</math>; Waveform: Half-sine shock plus; Duration: <math>11\text{msec}</math>; 3 drops each to normal and reversed directions of X, Y and Z axes; Per EIA-364-27. 速度 <math>490\text{m/s}^2</math>; 半正弦波；持續 11 毫秒；<math>\pm X, \pm Y, \pm Z</math>，方向各 3 次；適用：EIA-364-27。</p>
<p>11. Humidity-Temperature Cycle 溫濕度循環</p>	<p>After testing, no damage, Dielectric Withstanding Voltage should be OK, Power contact resistance <math>0.6\text{m}\Omega</math> max and signal contact resistance change <math>10\text{ m}\Omega</math> max. 測試後產品無損壞，耐電壓測試 OK，電源針接觸阻抗最大 <math>0.6\text{m}\Omega</math>，信號針接觸阻抗比初始值增大不超過 <math>10\text{ m}\Omega</math>。</p>	<p>Subject product to <math>25\sim 65^{\circ}\text{C}</math>, 90-95%.R.H 10Cycles. Each cycle lasted 24 hours, Per EIA-364-31. 產品置於 <math>25\sim 65^{\circ}\text{C}</math>，相對濕度：90-95%，循環 10 次，24 小時循環一次，適用：EIA-364-31</p>



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<p>12. Test temperature rise for rating current 溫升測試</p>	<p>The test temperature above ambient shall not exceed RTI(130°C) for UL. 測試溫度不能超過 UL 标准的 RTI(130°C)值。 Ambient conditions - Still air 25°C。 周圍環境溫度 25°C。</p>	<p>Subject mated contacts assembled in housing to closed circuit of Power Pin: 55A max. Signal Pin:4A max. Per EIA-364-70. 所述固定在外殼包的端子連結到一個封閉回路中測試，Power Pin:55A, Signal Pin: 4A。適用：EIA-364-70。</p>
	<p>The test temperature rise above ambient shall not exceed 30°C. 測試溫度升高值不能超過 30°C。 Ambient conditions - Still air 25°C。 周圍環境溫度 25°C。</p>	<p>Subject mated contacts assembled in housing to closed circuit of Power Pin: 51.5A(6ozX6) max. Signal Pin:4A(6ozX6) max. Per EIA-364-70. 所述固定在外殼包的端子連結到一個封閉回路中測試，Power Pin:51.5A(6ozX6), Signal Pin: 4A (6ozX6)。適用：EIA-364-70。</p>
<p>13. Salt Spray 鹽霧</p>	<p>After testing, no damage, Dielectric Withstanding Voltage should be OK, Power contact resistance 0.6mΩ max and signal contact resistance change 10 mΩ max. 測試後產品無損壞，耐電壓測試 OK，電源針接觸阻抗最大 0.6mΩ，信號針接觸阻抗比初始值增大不超過 10 mΩ。</p>	<p>5±1% salt concentration(PH=7.0) ,48 hours 35±2°C: Per EIA-364-26. 鹽水濃度 5±1%(PH=7.0),時間 48 小時，溫度 35±2°C。適用：EIA-364-26。</p>
<p>14. High Temperature Life 高溫老化</p>	<p>After testing, no damage, Dielectric Withstanding Voltage should be OK, Power contact resistance 0.6mΩ max and signal contact resistance change 10 mΩ max. 測試後產品無損壞，耐電壓測試 OK，電源針接觸阻抗最大 0.6mΩ，信號針接觸阻抗比初始值增大不超過 10 mΩ。</p>	<p>Subject product to 105°C for 240 hours continuously. Per EIA-364-17. 產品置於 105°C 連續 240 小時。 適用：EIA-364-17。</p>
<p>15. Solderability 可焊性</p>	<p>There shall have a solder coverage of 95% minimum。 產品在測試完成後，焊接部位粘錫面積大於 95%。</p>	<p>Soldering time: 5 seconds. Temperature: 245±5°C. Per EIA-364-52. 焊接時間：5 秒。 溫度：245±5°C。 適用：EIA-364-52。</p>



**Table II: Product Qualification Test Sequence**

附表二：產品測試順序

Test Description 測試描述	Test Group 測試分組									
	A	B	C	D	E	F	G	H	I	J
1. Conformation of Product 產品確認	1,7	1	1,9	1,9	1,9	1,9	1,9	1,9	1,9	1
2. Contact Resistance 接觸阻抗	2,6		2,6	2,6	2,6	2,6	2,6	2,6	2,6	
3. Insulation Resistance 絕緣阻抗	3		3,7	3,7	3,7	3,7	3,7	3,7	3,7	
4. Dielectric Withstanding Voltage 耐電壓	4		4,8	4,8	4,8	4,8	4,8	4,8	4,8	
5. Durability 耐久性	5									
6. Contact Retention Force 端子保持力		3								
7. Mating/Un-mating Force 插入/拔出力		2								
8. Vibration Sinusoidal Low Frequency 低頻正弦振動			5							
9. Thermal Shock 溫度衝擊				5						
10. Mechanical Shock 機械沖擊					5					
11. Humidity-Temperature Cycle 溫濕度循環						5				
12. Current rating 溫升測試							5			
13. Salt Spray 鹽霧								5		
14. High Temperature Life 高溫老化									5	
15. Solder-ability 可焊性										2

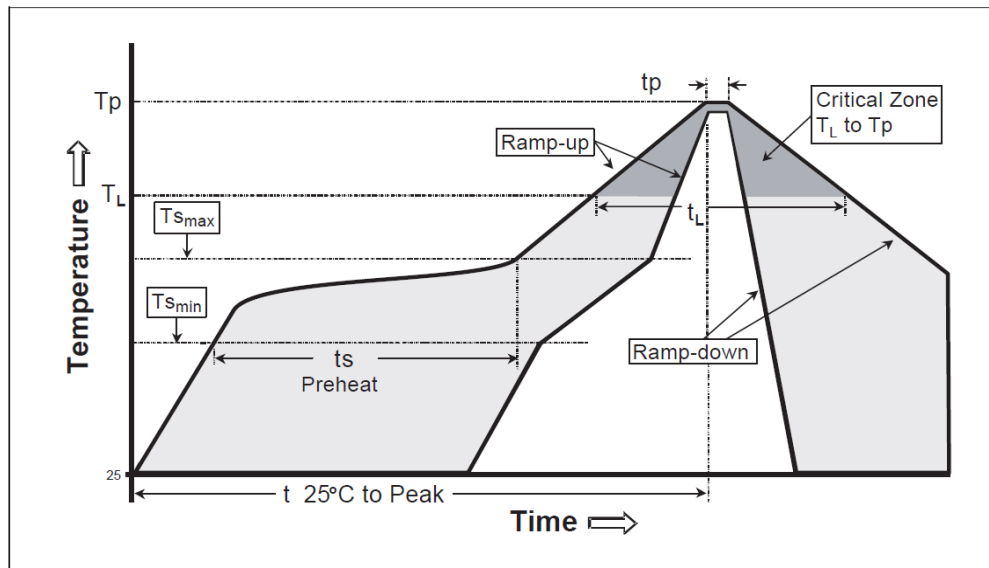
**Table III: Reflow Soldering Profile**

附表三：回流焊接曲線圖

Lead-free reflow profile requirements:

無鉛回流焊接曲線

Parameter 参数	Reference 参考	Specification 规格
升溫區 Ramp-up	25°C ~150°C	3°C /S Max
預熱區(Pre-heating) Temperature Min( $T_{s_{min}}$ ) Temperature Max( $T_{s_{max}}$ ) Time( $T_{s_{min}}$ to $t_{s_{max}}$ )	150°C ~200°C	60~180sec
Time maintained above(保持時間) Temperature( $T_L$ ) Time( $t_L$ )	217°C	60~150sec
Time within 5°C of actual peak Temperature( $t_p$ )	260-/+5°C	20~40sec
冷卻區 Cooling	Ramp-Down Rate	6°C /S(Max)
Time 25°C to Peak Temperature	25°C ~ Peak Temp.	8 minutes maximum



This profile is the minimum requirement for evaluating soldering heat resistance of components .Heat transfer method used for reflow soldering is hot air convection .The actual air temperatures used to achieve the specified profile largely dependent on the reflow equipment.

這個曲線圖是評估元件器件焊接抗熱的基本要求。應用在對焊接中的熱傳遞方式是熱氣對流。達到特定曲線圖地實際溫度主要依賴與回流焊接設備。



Table IV : Weld the curve graph in crest

附表四：波峰焊曲線圖

